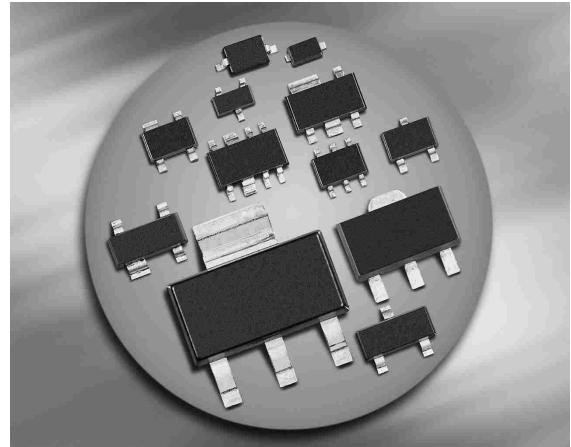


NPN Silicon Switching Transistors

- High DC current gain: 0.1 mA to 100 mA
- Low collector-emitter saturation voltage
- For SMBT3904S:
Two (galvanic) internal isolated transistors
with good matching in one package
- Complementary types: SMBT3906... MMBT3906
- SMBT3904S: For orientation in reel
see package information below
- Pb-free (RoHS compliant) package
- Qualified according AEC Q101



Type	Marking	Pin Configuration						Package
SMBT3904/MMBT3904	s1A	1=B	2=E	3=C	-	-	-	SOT23
SMBT3904S	s1A	1=E1	2=B1	3=C2	4=E2	5=B2	6=C1	SOT363

Maximum Ratings

Parameter	Symbol	Value	Unit
Collector-emitter voltage	V_{CEO}	40	V
Collector-base voltage	V_{CBO}	60	
Emitter-base voltage	V_{EBO}	6	
Collector current	I_C	200	mA
Total power dissipation- $T_S \leq 71^\circ\text{C}$, SOT23, SMBT3904	P_{tot}	330	mV
$T_S \leq 115^\circ\text{C}$, SOT363, SMBT3904S		250	
Junction temperature	T_J	150	$^\circ\text{C}$
Storage temperature	T_{stg}	-65 ... 150	

Thermal Resistance

Parameter	Symbol	Value	Unit
Junction - soldering point ¹⁾ SMBT3904/MMBT3904	R_{thJS}	≤ 240	K/W
SMBT3904S		≤ 140	

¹For calculation of R_{thJA} please refer to Application Note AN077 (Thermal Resistance Calculation)

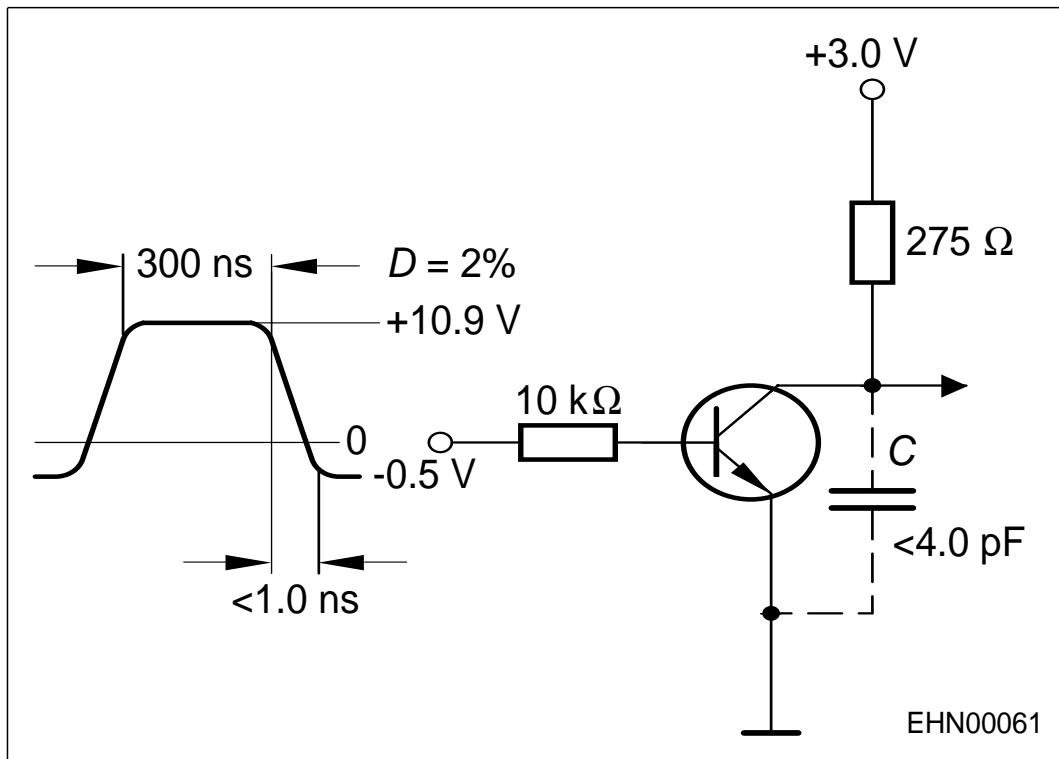
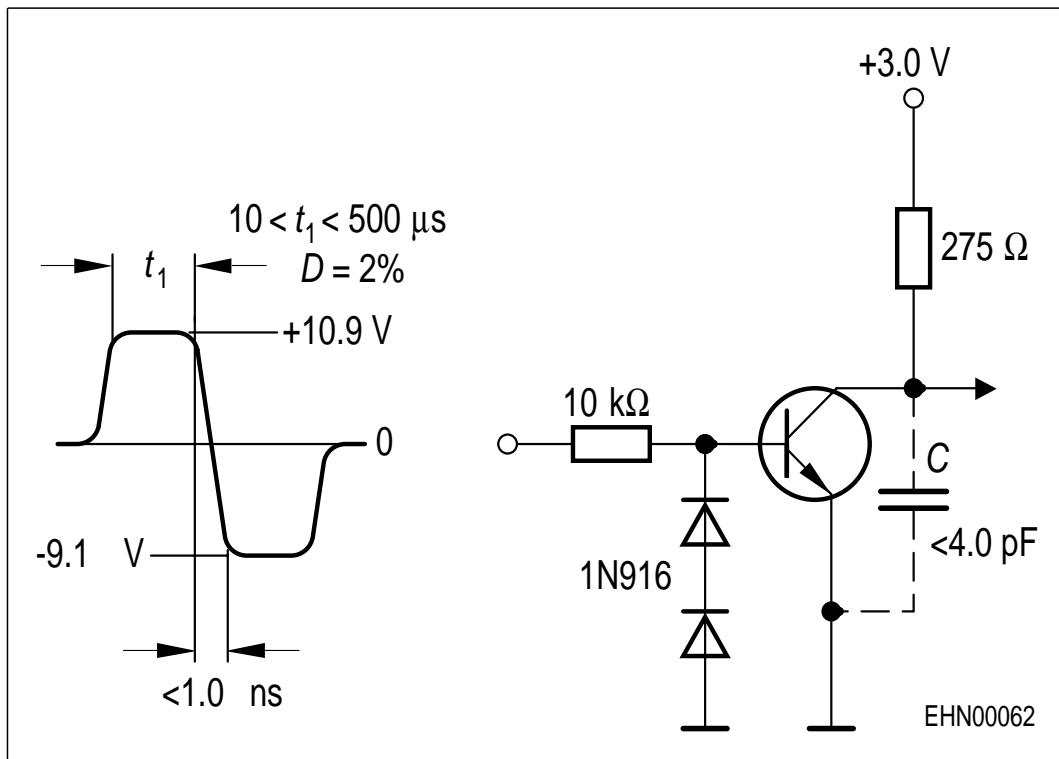
Electrical Characteristics at $T_A = 25^\circ\text{C}$, unless otherwise specified

Parameter	Symbol	Values			Unit
		min.	typ.	max.	
DC Characteristics					
Collector-emitter breakdown voltage $I_C = 1 \text{ mA}, I_B = 0$	$V_{(\text{BR})\text{CEO}}$	40	-	-	V
Collector-base breakdown voltage $I_C = 10 \mu\text{A}, I_E = 0$	$V_{(\text{BR})\text{CBO}}$	60	-	-	
Emitter-base breakdown voltage $I_E = 10 \mu\text{A}, I_C = 0$	$V_{(\text{BR})\text{EBO}}$	6	-	-	
Collector-base cutoff current $V_{\text{CB}} = 30 \text{ V}, I_E = 0$	I_{CBO}	-	-	50	nA
DC current gain ¹⁾ $I_C = 100 \mu\text{A}, V_{\text{CE}} = 1 \text{ V}$ $I_C = 1 \text{ mA}, V_{\text{CE}} = 1 \text{ V}$ $I_C = 10 \text{ mA}, V_{\text{CE}} = 1 \text{ V}$ $I_C = 50 \text{ mA}, V_{\text{CE}} = 1 \text{ V}$ $I_C = 100 \text{ mA}, V_{\text{CE}} = 1 \text{ V}$	h_{FE}	40 70 100 60 30	- - - - -	- - 300 - -	-
Collector-emitter saturation voltage ¹⁾ $I_C = 10 \text{ mA}, I_B = 1 \text{ mA}$ $I_C = 50 \text{ mA}, I_B = 5 \text{ mA}$	V_{CEsat}	- -	- -	0.2 0.3	V
Base emitter saturation voltage ¹⁾ $I_C = 10 \text{ mA}, I_B = 1 \text{ mA}$ $I_C = 50 \text{ mA}, I_B = 5 \text{ mA}$	V_{BEsat}	0.65 -	- -	0.85 0.95	

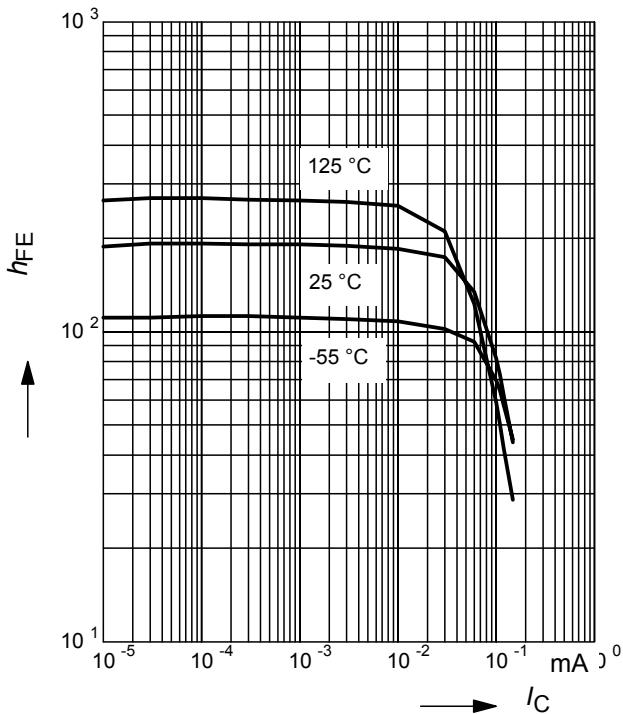
¹Pulse test: $t < 300\mu\text{s}$; $D < 2\%$

Electrical Characteristics at $T_A = 25^\circ\text{C}$, unless otherwise specified

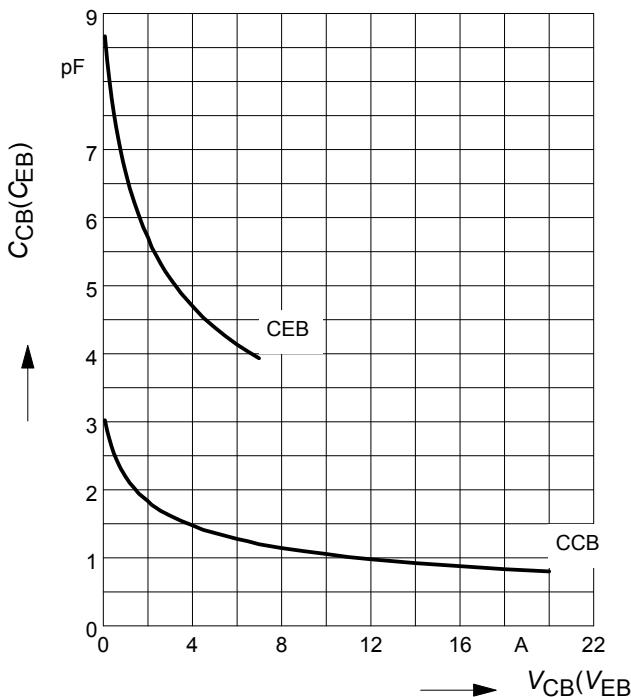
Parameter	Symbol	Values			Unit
		min.	typ.	max.	
AC Characteristics					
Transition frequency $I_C = 10 \text{ mA}, V_{CE} = 20 \text{ V}, f = 100 \text{ MHz}$	f_T	300	-	-	MHz
Collector-base capacitance $V_{CB} = 5 \text{ V}, f = 1 \text{ MHz}$	C_{cb}	-	-	3.5	pF
Emitter-base capacitance $V_{EB} = 0.5 \text{ V}, f = 1 \text{ MHz}$	C_{eb}	-	-	8	
Delay time $V_{CC} = 3 \text{ V}, I_C = 10 \text{ mA}, I_{B1} = 1 \text{ mA}, V_{BE(\text{off})} = 0.5 \text{ V}$	t_d	-	-	35	ns
Rise time $V_{CC} = 3 \text{ V}, I_C = 10 \text{ mA}, I_{B1} = 1 \text{ mA}, V_{BE(\text{off})} = 0.5 \text{ V}$	t_r	-	-	35	
Storage time $V_{CC} = 3 \text{ V}, I_C = 10 \text{ mA}, I_{B1} = I_{B2} = 1 \text{ mA}$	t_{stg}	-	-	200	
Fall time $V_{CC} = 3 \text{ V}, I_C = 10 \text{ mA}, I_{B1} = I_{B2} = 1 \text{ mA}$	t_f	-	-	50	
Noise figure $I_C = 100 \mu\text{A}, V_{CE} = 5 \text{ V}, f = 1 \text{ kHz}, \Delta f = 200 \text{ Hz}, R_S = 1 \text{ k}\Omega$	F	-	-	5	dB

Test circuits
Delay and rise time

Storage and fall time


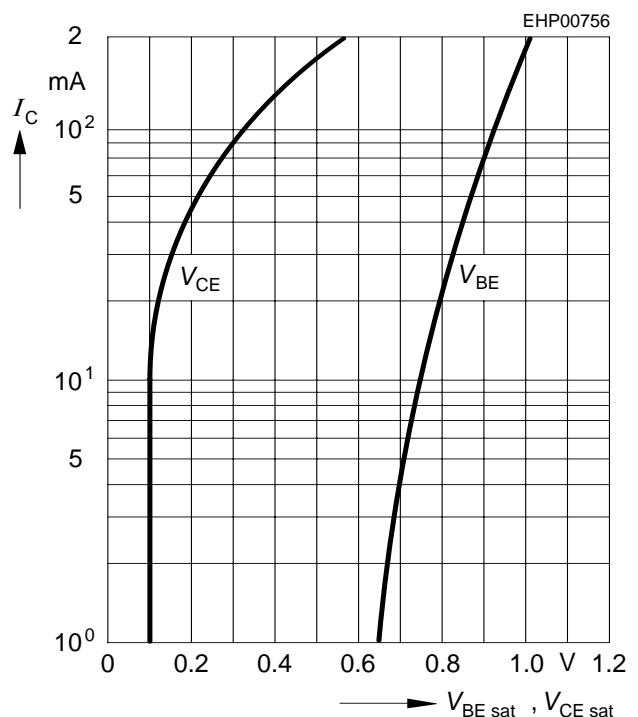
DC current gain $h_{FE} = f(I_C)$
 $V_{CE} = 1 \text{ V}$, normalized



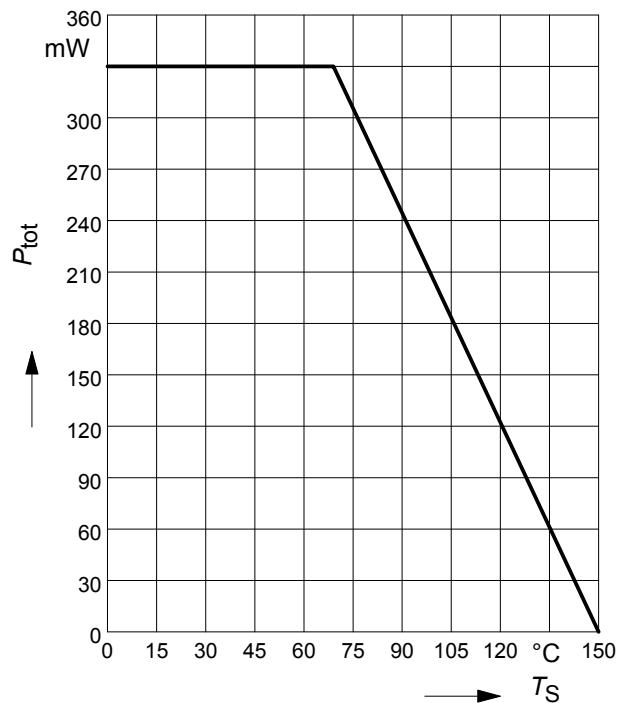
Collector-base capacitance $C_{cb} = f(V_{CB})$
Emitter-base capacitance $C_{eb} = f(V_{EB})$



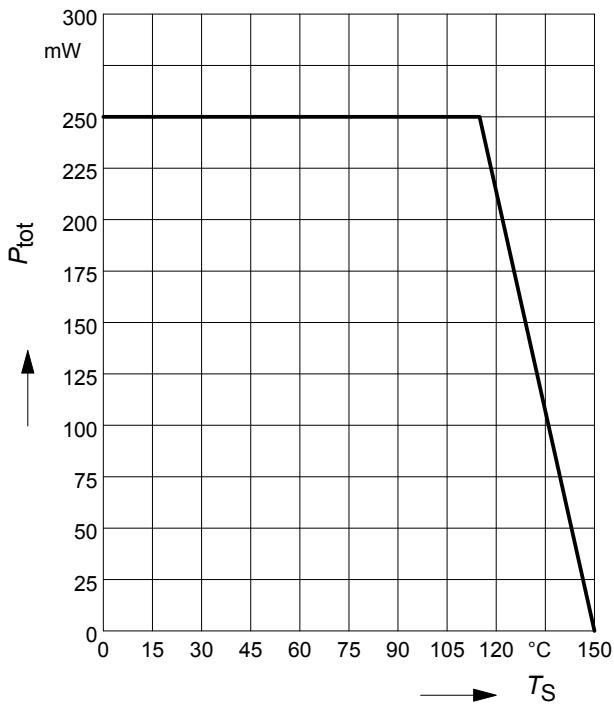
Saturation voltage $I_C = f(V_{BEsat}, V_{CESat})$
 $h_{FE} = 10$



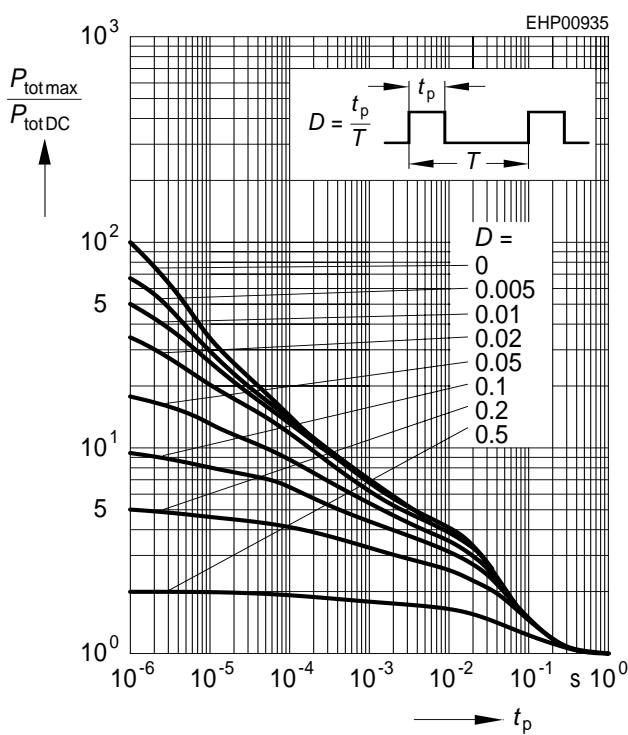
Total power dissipation $P_{tot} = f(T_S)$
SMBT3904/MMBT3904



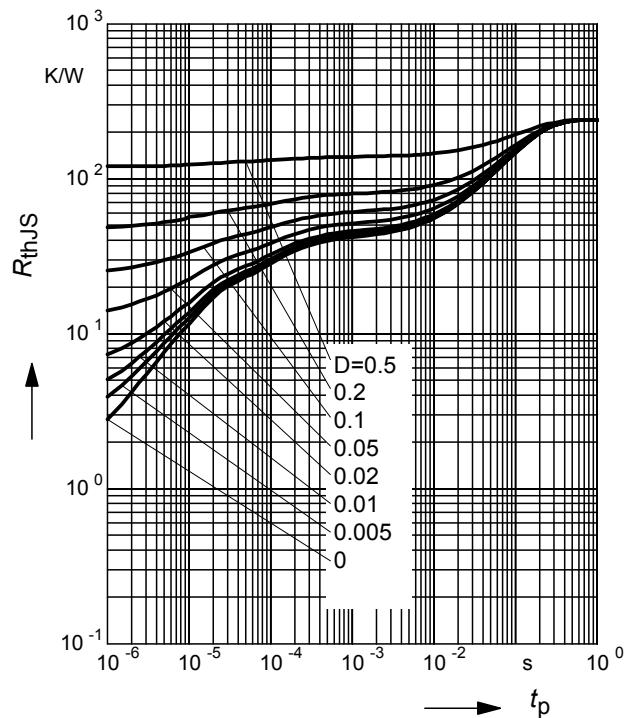
Total power dissipation $P_{\text{tot}} = f(T_S)$
SMBT3904S



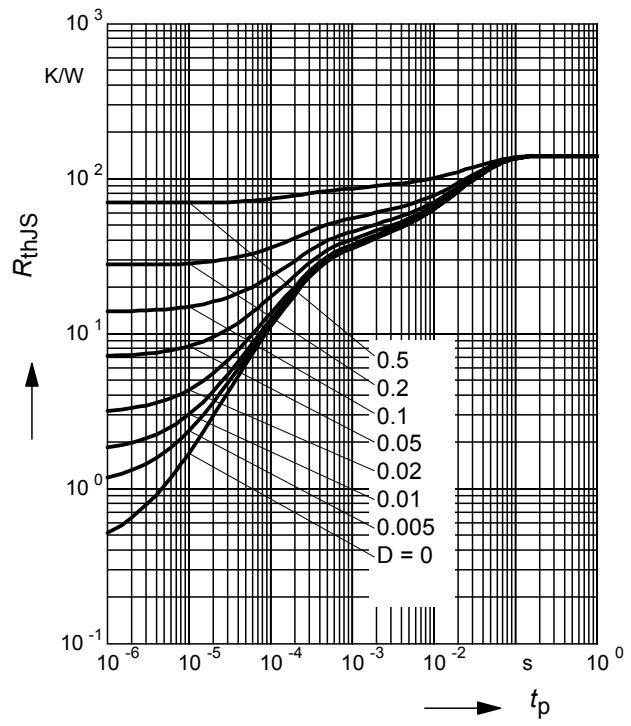
Permissible Pulse Load
 $P_{\text{totmax}}/P_{\text{totDC}} = f(t_p)$
SMBT3904/MMBT3904



Permissible Pulse Load $R_{\text{thJS}} = f(t_p)$
SMBT3904/ MMBT3904



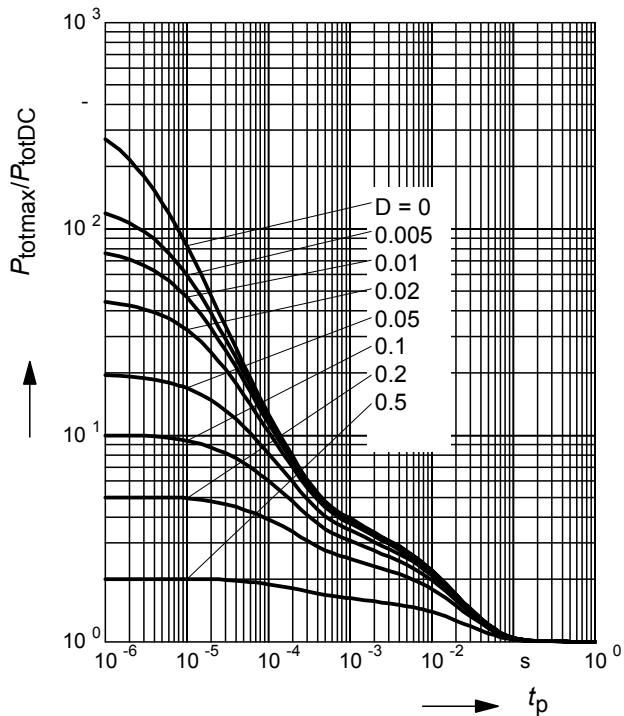
Permissible Pulse Load $R_{\text{thJS}} = f(t_p)$
SMBT3904S



Permissible Pulse Load

$$P_{\text{totmax}}/P_{\text{totDC}} = f(t_p)$$

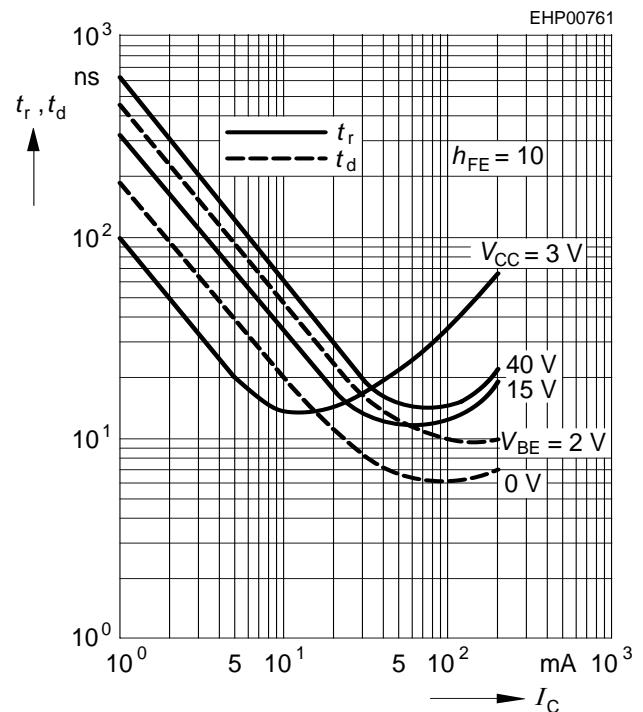
SMBT3904S



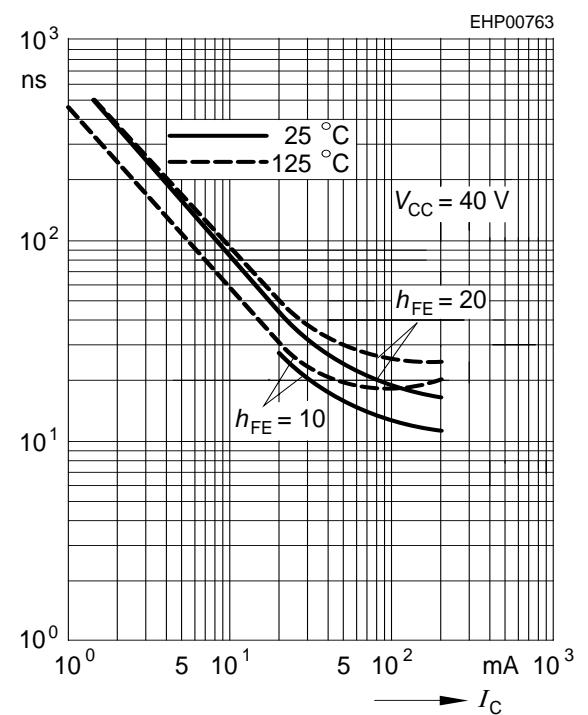
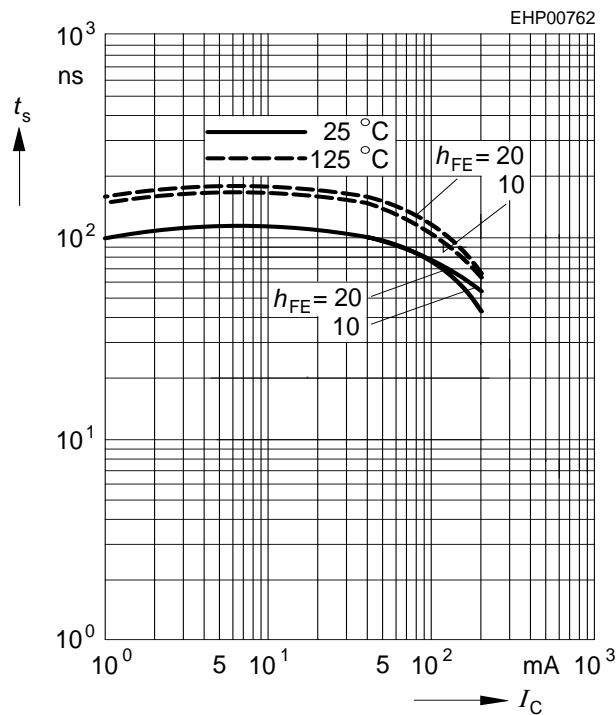
Storage time $t_{\text{stg}} = f(I_C)$

Delay time $t_d = f(I_C)$

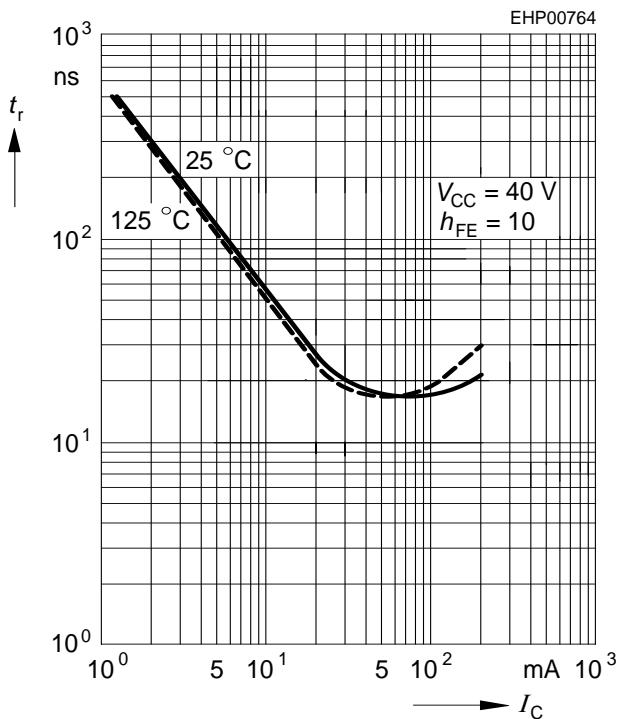
Rise time $t_r = f(I_C)$



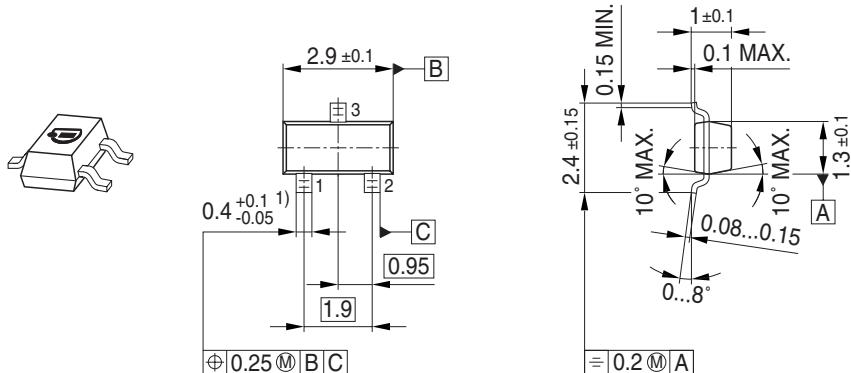
Fall time $t_f = f(I_C)$



Rise time $t_r = f(I_C)$

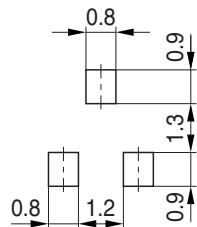


Package Outline

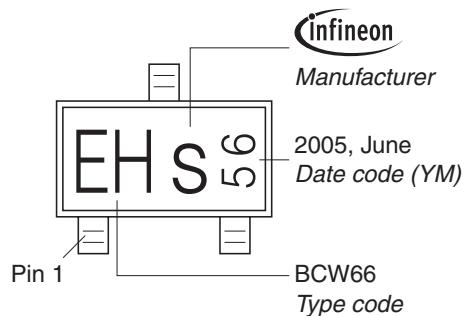


1) Lead width can be 0.6 max. in dambar area

Foot Print

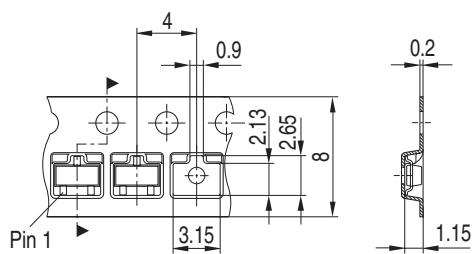


Marking Layout (Example)

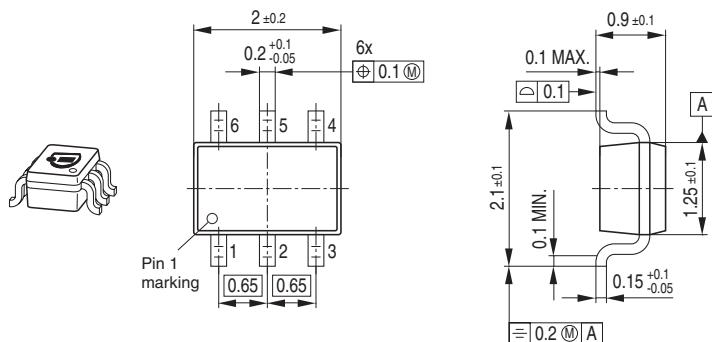


Standard Packing

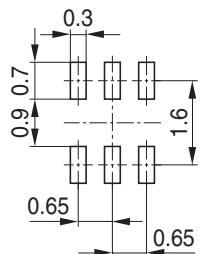
Reel ø180 mm = 3.000 Pieces/Reel
Reel ø330 mm = 10.000 Pieces/Reel



Package Outline

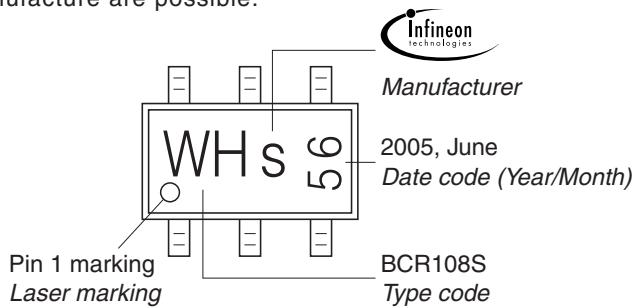


Foot Print



Marking Layout (Example)

Small variations in positioning of Date code, Type code and Manufacture are possible.



Standard Packing

Reel ø180 mm = 3.000 Pieces/Reel

Reel ø330 mm = 10.000 Pieces/Reel

For symmetric types no defined Pin 1 orientation in reel.

